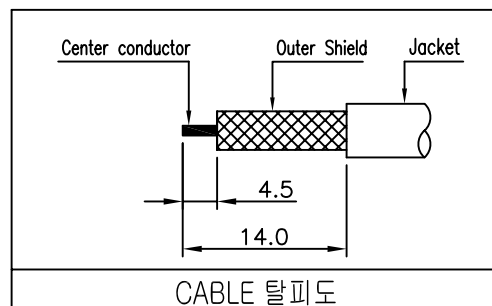
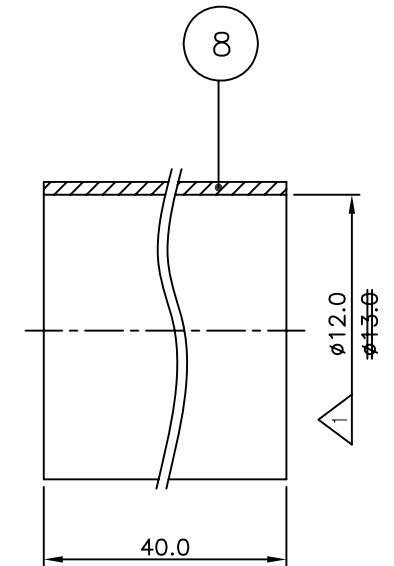
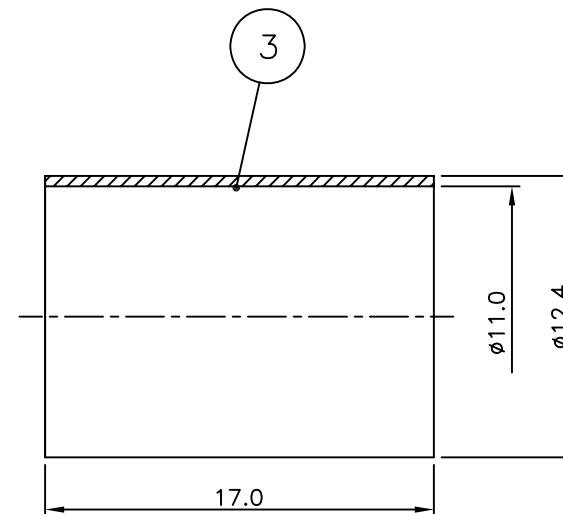
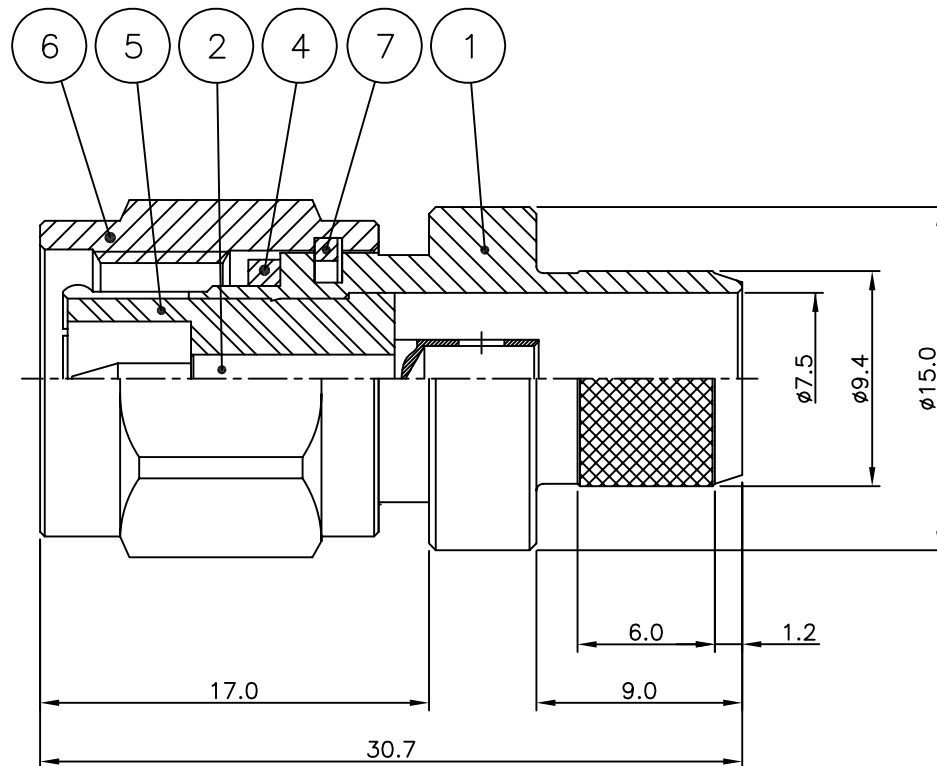


REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
IR	Initial Registration	S.Y.EUN	I.C.KIM	2020.07.30.
1	생산팀 요청으로 인한 봉딩튜브 사이즈 변경 (Ø13 → Ø12)	S.Y.EUN	I.C.KIM	2021.02.24.
2	커넥트 압착부 바디 부러짐 현상 방지로 인한 R추가	S.Y.EUN	S.H.KIM	2022.01.03.



ELECTRICAL SPEC

1. Frequency Range : DC ~ 3GHz
2. Impedance : 50Ω
3. V.S.W.R.(Max) : 1.2

1	8	BONDING TUBE	1			ATU00012-N/1 ATU00013-N/1
	7	SPRING RING	1	SUS	Passivated	DSR00024-5/1
	6	CAP	1	MBsBD C3604BD-F	Nickel Plated	DCU00135-5/6
	5	INSULATOR	1	TEFLON		DIN01734-5/1
	4	GASKET	1	SILICON RUB		DGK00008-N/1
	3	FERRULE	1	MBsBD C3604BD-F	Nickel Plated	DfE00070-5/1
	2	CONTACT	1	MBsBD C3604BD-F	Gold Plated	DCT02213-5/1
2	1	BODY	1	MBsBD C3604BD-F	Nickel Plated	DBD02701-5/8
	NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal	DATE			 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017	
	±0.1	2022. 01. 03.				
	Angle	APPROVED BY	S.H.KIM			
MATERIAL	±1°	CHECKED BY	TITLE			
	-	DRAWN BY	TNC50 CABLE PS LMR400			
FINISH						
	-	SCALE	UNIT	A4	DWG NO.	
		3/1	mm		CN00380-7/6	
				REVISION	SHEET	
				2	1 of 1	